Low cost alternative to DIP switches

Increases current flow and decreases resistance vs DIP switches

■ Dual beam terminals: 2 points of contact per pin

Open and closed top versions

■ Stackable end-to-end and side-to-side

Reference Information

Product Specification: PS-7859

Packaging: Bag UL File No.: E29179 (H) CSA File No.: LR19980A

Mates With: All C-Grid breakaway headers

Designed In: Inches

Electrical

Voltage: 250V Current: 5.0A

Contact Resistance: $15m\Omega$ max. Gold Dielectric Withstanding Voltage: 1500V Insulation Resistance: 100K M Ω min.

Mechanical

Contact Retention to Housing: 26.69N (4 lb)

Mating Force: 4.448N (6 lb) Unmating Force: 0.98N (1 lb)

Durability: 25 cycles Tin/Lead and 200 cycles Gold

Physical

Housing: Glass-filled polyester, UL 94V-0

Contact: Phosphor Bronze Plating: See Table

Operating Temperature: -40 to +105°C

molex

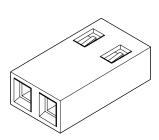
molex[®] 2.54mm (.100") Pitch

 $\text{C-Grid}^{\mathbb{R}}$

Shunt/Jumper

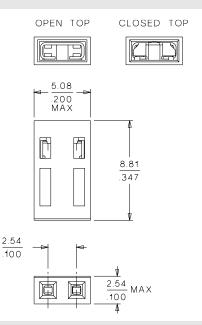
7859

2-Circuit



CATALOG DRAWING (FOR REFERENCE ONLY)

Not For Use With C-Grid III™ Components



ORDERING INFORMATION

Ореп Тор		Closed Top	
Order No.	Plating	Order No.	Plating
• 15-29-1024	15μ" Gold	15-29-1025	15μ" Gold
• 15-29-1026	30μ" Gold	15-29-1027	30μ" Gold
• 15-38-1024	150µ" Tin/Lead	15-38-1026	150µ" Tin/Lead

[•] US Standard Product, available through Molex franchised distributors

C-82 MX01